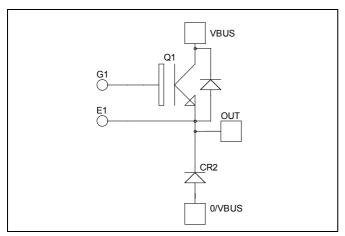


## **Buck** chopper Trench + Field Stop IGBT3 Power Module

$$V_{CES} = 600V$$
  
 $I_{C} = 450A$  @  $Tc = 80$ °C

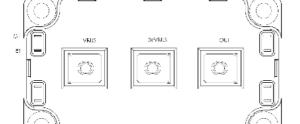


## Application

- AC and DC motor control
- Switched Mode Power Supplies

#### **Features**

- Trench + Field Stop IGBT3 Technology
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 20 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration



#### **Benefits**

- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- **RoHS Compliant**

### Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
$V_{CES}$	Collector - Emitter Breakdown Voltage		600	V
$I_{\rm C}$	Continuous Collector Current	$T_C = 25^{\circ}C$	550	
	Continuous Conector Current	$T_C = 80^{\circ}C$	450	Α
$I_{CM}$	Pulsed Collector Current	$T_C = 25^{\circ}C$	600	
$V_{GE}$	Gate – Emitter Voltage		±20	V
$P_{D}$	Maximum Power Dissipation	$T_C = 25$ °C	1750	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^{\circ}C$	900A @ 550V	

These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



### All ratings @ $T_j = 25$ °C unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 600V$				500	μΑ
V <sub>CE(sat)</sub>	Collector Emitter Saturation Voltage	$V_{GE} = 15V$	$T_j = 25$ °C		1.4	1.8	V
V CE(sat)	Conector Emitter Saturation Voltage	$I_{\rm C} = 450 A$	$T_j = 150$ °C		1.5		•
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 2mA$		5.0	5.8	6.5	V
$I_{GES}$	Gate – Emitter Leakage Current	$V_{GE} = 20V, V_{CE} = 0V$				600	nA

**Dynamic Characteristics** 

·	Characteristic	Test Conditions		Min	Тур	Max	Unit
Cies	Input Capacitance	$V_{GE} = 0V$ $V_{CE} = 25V$ $f = 1MHz$			37		nF
$C_{oes}$	Output Capacitance				2.3		
$C_{res}$	Reverse Transfer Capacitance				1.1		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C)			130		
$T_{r}$	Rise Time	$V_{GE} = \pm 15V$			55		
$T_{d(off)}$	Turn-off Delay Time	$V_{\text{Bus}} = 300V$ $I_{\text{C}} = 450A$			250		ns
$T_{\mathrm{f}}$	Fall Time	$R_G = 1\Omega$		60			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (150°C) $V_{GE} = \pm 15V$ $V_{Bus} = 300V$ $I_{C} = 450A$ $R_{G} = 1\Omega$			145		ns
$T_{r}$	Rise Time				60		
$T_{d(off)}$	Turn-off Delay Time				320		
$T_{\mathrm{f}}$	Fall Time				80		
Б		$V_{GE} = \pm 15V$	$T_j = 25^{\circ}C$		2.25		ma T
$\mathbf{E}_{\mathrm{on}}$		$V_{\text{Bus}} = 300\text{V}$	$T_{j} = 150^{\circ}C$		4.2		mJ
Б	Turn off Energy	$I_{\rm C} = 450 {\rm A}$	$T_j = 25^{\circ}C$		12.8		mJ
$E_{off}$	Turn off Energy	$R_G = 1\Omega$	$T_{j} = 150^{\circ}C$		15.7		1117

Chopper diode ratings and characteristics

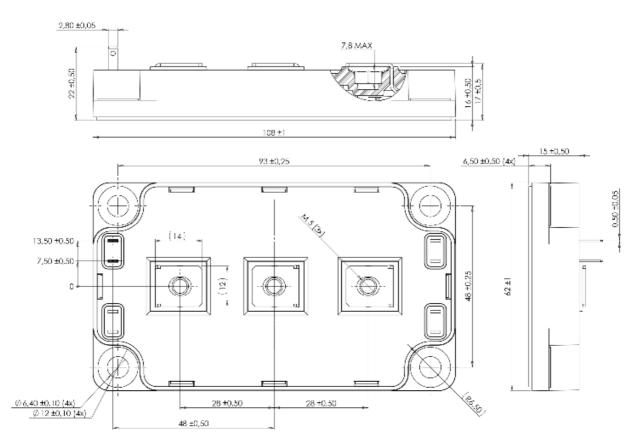
Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage			600			V
$I_{RM}$	Maximum Reverse Leakage Current	V <sub>R</sub> =600V	$T_i = 25$ °C $T_i = 150$ °C			200 500	μΑ
$I_{\mathrm{F}}$	DC Forward Current		$Tc = 80^{\circ}C$		450		A
$V_{\mathrm{F}}$	Diode Forward Voltage	$I_F = 450A$ $V_{GE} = 0V$	$T_i = 25^{\circ}C$		1.5	1.9	V
<b>v</b> F			$T_{i} = 150^{\circ}C$		1.4		v
+	Reverse Recovery Time	$I_F = 450A$ $V_R = 300V$ $di/dt = 4000A/\mu s$	$T_j = 25^{\circ}C$		120		ns
$t_{\mathrm{rr}}$			$T_j = 150$ °C		210		
	Reverse Recovery Charge		$T_j = 25$ °C		20.3		C
$Q_{rr}$			$T_{i} = 150^{\circ}C$		42.8		μС
Е	Reverse Recovery Energy		$T_j = 25$ °C		5.2		mJ
$E_{r}$			$T_{\rm j} = 150^{\circ}{\rm C}$		10.6		1113



### Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
$R_{thJC}$	Junction to Case Thermal Resistance		IGBT			0.085	°C/W
M <sub>th/C</sub> Junction to Case Thermal Resistance			Diode			0.14	C/ W
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t = 1 min, 50/60Hz			4000			V
$T_{J}$	Operating junction temperature range			-40		175	
$T_{STG}$	Storage Temperature Range			-40		125	°C
$T_{\rm C}$	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	18.111
Wt	Package Weight					300	g

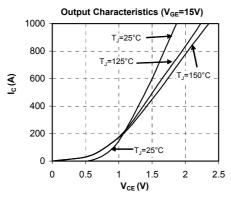
### SP6 Package outline (dimensions in mm)

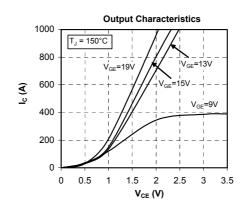


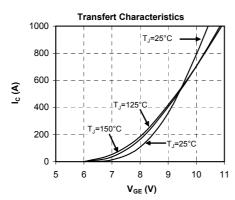
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

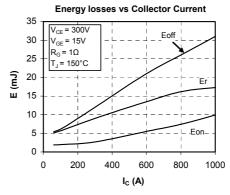


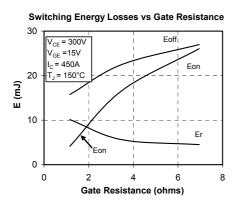
### **Typical Performance Curve**

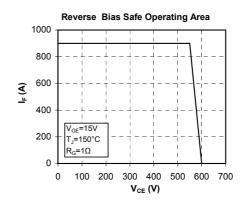


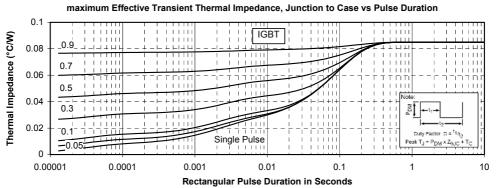




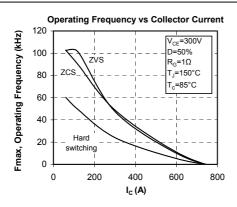


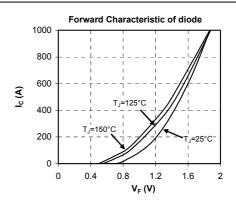


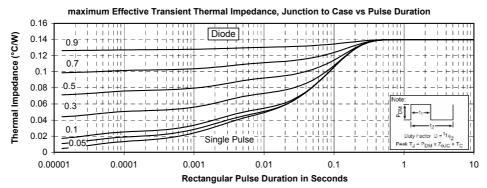












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